7<sup>th</sup> International Conference on New Developments In Photodetection

Tours, France, June 30th to July 4th 2014

# Micro-Channel Plates And Vacuum Detectors

NDIP

Thierry Gys (CERN/PH-DT)



NDIP Review Talk - 30 June 2014





- Much more has been and is taking place than what can be covered in 45 minutes!
- This (partially historical) review is actually a mix between an overview, a tutorial and a highlight from the viewpoint of a modest MCP user
- The selection criteria were a combination of
  - the speaker's past and current activities and interests
  - those MCP-related developments coming from relatively old, new and near-future R&D and experiment projects
  - topics which are generally covered in other oral or poster presentations during this
     Conference
  - topics the illustrations of which were easily accessible, directly via authors, publications and web sites





- History the channel electron multiplier
- From large-size single channels to micro-channel plates
- Gen II image intensifiers
- Applications in scintillating fibre tracker detectors
- Re-discovering the MCP-PMT for fast timing
- Applications in time-of-flight and particle identification and related recent developments
- Conclusions and perspectives



# History – the channel electron multiplier (CEM)





Further developed in 1960's

- Oschepkov et al.
  - No central electrode
  - TiO<sub>2</sub>+MgO
- Heroux and Hinteregger
  - SnO+Sb-coated glass
- Goodrich and Wiley
  - "They may either be made of a conducting coating on an insulating base or they may consist of the surface of a material with the proper volume resistivity for convenient operation"

Rev. Sci. Instr. 32 (1961) 846

Rev. Sci. Instr. 31

(1960) 280

channel; 4) electron collector; 5) instrument for recording the output current;  $\Phi_0$ ) primary radia-

tion which produces electron emission from the



US Patent 1,969,399





internal surface.



## History – the CEM (2)













•



- Production of resistive surfaces in Pb-glass by high T reduction in hydrogen
  - See K. Blodgett J. Am. Ceram. Soc. 34,1 (1951) 14
- The same technology that produced optical fibres and fibre optic bundles, with a slight change in manufacturing, allowed the production of micro-channel plates
- Manufacturing steps
  - Hollow tube of non-etchable glass
  - Core of etchable glass
  - Heated and drawn (0.8mm ø)
  - Bundled to hexagon rod
  - Drawn again
  - Fused and sliced
  - Polished and etched
  - Heated under H<sub>2</sub> and "electroded" (NiCr)
  - Pre-conditioning through electron scrubbing
- Glass surface resistivities  $10^7$  to  $10^{13} \ \Omega/\Box$



VALVO





NIM162 (1979) 587



## Micro-channel plates



- Geometry
  - d~6-25µm ٠
  - L~400-1000µm ٠
  - $\alpha$ =L/d~40-100, defines gain ٠
  - OAR~55-65% ٠
- Straight channel •
  - Typical gain 10<sup>3</sup>-10<sup>4</sup> •
  - **IFB** limited •
  - **Negative exponential PHS**  $\bullet$
- **Curved channel** •
  - Space-charge limited dynamic equilibrium •
  - **Quasi Gaussian PHS** •
  - Difficult to bend if small-sized •
- Chevron
  - Typical gain 10<sup>6</sup>-10<sup>7</sup>
  - Gain  $\div$  d for fixed V/ $\alpha$
  - PHS







**NIM162** 





- Driving market
  - Night vision
  - Military applications
- Typical structure
  - Optical input window
  - Photocathode
  - MCP (chevron)
  - Phosphor screen
  - Optical fibre bundle
  - CCD readout

http://www.microscopyu.com /print/articles/digitalimaging/ digitalintro-print.html







Gen I

Gen II



- Image features
  - High gain
  - No pin-cushion distortion (Gen I)
- Spatial resolution (and time)
  - Photon energy
  - Tube gaps
- Halos (and time tails)
  - Back-scattering
  - Tube gaps
    - PC-MCPin gap can be as small as 120µm
- End-spoiling
  - Increased spatial resolution
  - ... to some extent (lens effect)
  - What about timing effects?



Acta Electronica 20,4 (1977) 369





 $\begin{array}{c}
60V \\
\hline
0.1V \\
\hline
d
\end{array}$ 

J. Vac. Sci. Tech. B 19 (2001) 843

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V(E)





- UA2 tracker upgrade
  - Search of e- with p<sub>T</sub>~10-30GeV/c as a signature for top quark production
  - Cascade of 3 image intensifiers
  - 1<sup>st</sup> stage is Gen I
    - Good coverage
    - De-magnification required to match Gen II size
  - 2<sup>nd</sup> stage is Gen II
    - High gain
  - 3<sup>rd</sup> stage is Gen I
    - De-magnification required to match CCD size





NIMA344 (1994) 143

- CHORUS
  - Search for  $v_{\mu}$ - $v_{\tau}$  oscillations
  - Fibre tracker restricts search for vertex location
     ν<sub>τ</sub>, N -> τ-, X in bulk emulsion

NIMA289 (1990) 342 3 2 1



- WA84
  - Beauty search with scifi microvertex detector



# Re-discovering the MCP-PMT for fast timing



- Some interesting features
  - Square shapes
    - Better overall coverage
  - Single-photon sensitive
  - High gain
  - Collection efficiency ~ 60%
  - Compact, high E field
    - Small TTS
    - Works in large (axial) magnetic fields
    - Good rate capability (the smaller d the better)
  - Position-sensitive
    - Appropriate anode segmentation





Hamamatsu



NIMA 695 (2012) 68





- Photo-electron back-scattering
  - Tails in spatial and timing distributions
  - Spatially
    - Worst case: elastic scattering @ 45°
    - Range twice PC/MCPin gap
  - Timing
    - Worst case: elastic scattering @ 90°
    - Range twice transit time PC/MCPin









- Secondary electrons spread when traveling from MCPout to anode
- May hit more than one anode pad → Charge sharing
- May improve spatial resolution but degrade time resolution



Fraction of the charge detected by left pad as a function of light spot position (red laser)



Y

e

Slices at equal charge sharing for red and blue laser at pad boundary Resolution limited by photoelectron energy.

 $\int \frac{54}{x} [mm]$ 

50

50

52

54

x[mm]

52





- Narrow amplification channel and proximity focusing electron optics allow operation in magnetic field (~axial direction)
- Amplification depends on magnetic field strength and direction
- Effects of charge sharing and photoelectron backscattering on position resolution are strongly reduced while effects on timing remain



NIMA595 (2008) 173



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T. Gys - MCPs and Vacuum Detectors





- During the amplification process
  - Atoms of residual gas get ionized and/or desorbed
  - Travel back towards the photocathode and produce secondary pulse
- Ion bombardment damages the photocathode reducing QE
- Atoms may react with and degrade the photocathode
- Overall gain reduction also seen







- Improve vacuum quality
- Improve MCP scrubbing
- Make more robust photocathodes
- Investigate new thin-film technologies
- Investigate alternative MCP materials
  - Borosilicate, Alumina, Silicon
- Implement ion barrier film
  - 5-10nm Al<sub>2</sub>O<sub>3</sub>
  - On MCPin with 40% reduction of collection efficiency
  - Between MCPs
- Seal anode region from PC region





- Developed @ BINP for FARICH concept ٠
  - **Possible applications** •
    - Super c- $\tau$  factory (Novosibirsk)
    - ALICE •
    - •
    - PANDA forward RICH
- DCR ranges  $\bullet$ 
  - Na2KSb(Cs)+Cs3Sb: 50-100 kHz/cm<sup>2</sup> •
  - Na<sub>2</sub>KSb(Cs)+Cs: 5 kHz/cm<sup>2</sup> •
  - Na<sub>2</sub>KSb(Cs): 0.5 kHz/cm<sup>2</sup> •
  - Na<sub>2</sub>KSb: <0.5 kHz/cm<sup>2</sup> •
- Test operating parameters •
  - Counting rate 2-10MHz/cm<sup>2</sup> •
  - Gain 10<sup>6</sup> •
- Recoverable gain change



#### 2011 JINST 6 C12026











## See talk of O. Siegmund at this Conference

- Three-step deposition process
  - Resistive layer
  - Secondary emission layer
  - Electrode layer
- Optimization of MCP resistance and SEE
  - Independently for each film
  - For a given gain, lower operating voltage
- Allow use of insulating materials other than Pb-glass
- Initiated by the LAPPD Collaboration



#### Arradiance



NIMA607 (2009) 81–84







Amorphous Si-based  $\rightarrow$  See talk of F. Andrea at this Conference



# FDIRC/FTOF



## DIRC concept (BaBar) – 2D imaging





$$t_p = \frac{L_{path}}{v_g}$$
  $v_g = \frac{c}{n(\lambda) - \lambda \frac{dn}{d\lambda}}$  (group velocity)

### Required various MCP-related R&D



NIMA718 (2013)







## See talk of S. Hirose at this Conference

- Particle ID in Belle II
- TOP (Time-Of-Propagation)
  - Counter based on DIRC concept
  - Using linear array of MCP-PMTs to measure x coordinate and time of propagation (length of photon path)
  - Chromaticity dispersion 100ps
  - Evolved towards iTOP with focussing mirror and y coordinate

Quartz radiator
 With mirror and expansion block
 Mechanics, Quartz Bar Box (QBB)
 MCP-PMT + Readout electronics
 32 PMTs x 16ch = 512ch

100mm
456mm
100mm
456mm
100mm
16x2 MCP-PMTs
Readout electronics
16x2 MCP-PMTs
Freedout electronics
16x2 MCP-PMTs







# Belle II iTOP photon detectors



#### Physics Procedia 37 (2012) 683

#### NIMA 629 (2011) 111

- MCP-PMT requirements
  - Integrated charge
    - 1.2-2.4 C/cm<sup>2</sup>/50 ab<sup>-1</sup> (5x10<sup>5</sup> gain)
    - Lifetime 0.8QE
  - Enhanced multi-alkali (>28% QE at peak)
  - MCP
    - Channel  $\phi$  10 $\mu$ m
    - bias angle 13°
    - thickness 400µm
    - layers 2
  - Al protection layer on 2<sup>nd</sup> MCP + sealing + ALD
  - Anode channels 4×4
  - Sensitive region 64%
  - HV ~ 2500 3500 V
  - Readout: analogue sampling memory









K. Matsuoka RICH2013





- Time resolution: acceptable up to 100 ps (rms)
- T<sub>0</sub> jitter: acceptable up to 50 ps (rms)
- MCP-PMT signal is read out by newly developed "IRS" (Ice Radio Sampler) series of ASICs
  - Waveform sampling
  - Clear signal read out by ASIC
  - High density, multi-hit buffering 512ch / module, 30kHz trigger rate
  - Clock jitter measured with test pulse is about 20ps.





K. Inami RICH2013





## See talk of A. Lehmann at this Conference

- Interaction rate
  - cycle average: ~10 MHz
  - max. average: ~20 MHz
- Require K/π separation up to 4GeV/c
- Disc DIRC
  - Very limited space
  - B field 1-2T
  - ~ 3 "Cherenkov emitting" tracks per interaction
  - Triggerless operation
  - 1 MeV n-equivalent fluence >2.10<sup>11</sup> neq/cm<sup>2</sup>



O. Merle RICH2013



## PANDA Disc DIRC



- MCP-PMT requirements
  - Integrated charge ~ 5.6C/cm<sup>2</sup>
  - Rate ~ 225kHz/cm<sup>2</sup>
  - Bfield 1-2T
  - Segmentation 3x100 on 2" sq. tube
- ASIC candidate
  - TOF-PET Rolo et al. 2013 JINST 8 C02050





#### O. Merle RICH2013

NDIP Review Talk - 30 June 2014



## PANDA Barrel DIRC



- DIRC concept
- Design similar to BELLE II iTOP
- MCP-PMT requirements
  - Single photon detection
  - Spatial resolution ~ few mm
  - Fast rise time
  - Operation in 1 T field
  - High-rate capability ~0.2 MHz/cm<sup>2</sup>
  - Long lifetime: 0.5 C/cm<sup>2</sup> per year at 10<sup>6</sup> gain
  - Photonis 8x8





M. Hoek RICH2013





- Moderate MCP gain changes
- Decrease of DCR



#### A. Lehmann RICH2013







• Big improvement for ALD-processed MCPs



NIMA 695 (2012) 68







- DAQ system based on TRBv3 board (developed at GSI)
  - High-resolution TDC (<10 ps) based on FPGAs</li>
  - LVDS input signals
  - Precise timing
  - Amplitude information (ToT)
- Compare different technologies
  - ASIC: NINO chip (ALICE TOF)
  - FPGA: PADIWA (GSI)
  - From beam tests TTS O(50ps) achieved





M. Hoek RICH2013





## See talk of L. Castillo García at this Conference

- TORCH (Time Of internally Reflected CHerenkov light) is a possible solution for low-momentum particle ID in LHCb
- Largely inspired by Babar DIRC and iTOP concepts of Belle II
- Want positive identification of kaons in region below their threshold for producing light in the C<sub>4</sub>F<sub>10</sub> gas of RICH-1, i.e. p < 10 GeV/c</li>
- ΔTOF (π-K) = ~35 ps at 10 GeV/c over a distance of ~ 10 m
   → aim for ~15 ps resolution per track
- ERC-funded Project (ERC-2011-AdG, 291175-TORCH)



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#### NIMA639 (2011) 173



# TORCH reconstruction and photon detector requirements



- Reconstruction
  - Measure angles  $\theta_x$ ,  $\theta_z$  of photon trajectory with 1mrad precision to reconstruct photon path length
  - Require appropriate focussing optics at periphery and corresponding coarse  $(\theta_x)$  and fine  $(\theta_z)$  segmentation of photon detectors
- $\theta_z$   $\theta_z$   $\theta_z$  h  $\theta_z$  h  $\theta_z$  h  $\theta_z$  h  $\theta_z$   $\theta_z$  $\theta$



- MCP-PMT requirements
  - Segmentation 8x128 \_\_\_\_\_\_
     (~6.4mmx0.4mm for a 2" tube)
  - Typical gain 100fC (6x10<sup>5</sup>)
  - TTS 50ps for single photons (including electronics)
  - 100 tracks per event, 30 detected photons per track every 25ns
     => 1-10MHz/cm<sup>2</sup> detected photon rate
    - => 1-10C/cm<sup>2</sup> per year







# TORCH photon detectors – commercial and custom devices

Photonis



- Commercial MCP-PMTs
  - The closest candidates
    - Planacon 8x8 5.9 mm/6.5 mm in size/pitch
    - Planacon 32x32 1.1 mm/1.6 mm in size/pitch
  - Measured TTS for single photon
    - 38ps with single-channel electronics
    - ≤90ps with NINO/HPTDC (w/o time walk and non-linearity corrections)
  - Fine segmentation  $\rightarrow$  not OK
- Custom MCP-PMTs
  - Dedicated R&D programme subdivided in three phases

    - Circular devices with required segmentation
    - Square devices with extended lifetime and required







Photek

L. Castillo García et al.

ICATPP2013





**NIMA732** 

(2013) 388





- MCP concept is old but technology is still evolving and improving
- Most spectacular progress is on lifetime to be confirmed long-term on large quantities
- Trend towards finer anode spatial segmentation
- Readout electronics is a challenge
  - High channel count rate
  - High speed
  - High SNR
- Cost aspects!
- Some design guidelines
  - Survey of existing technologies
  - Collaboration with industry: as much as possible, try to combine/match requirements with industrial standards
  - Development of new photon detectors and their associated readout (front-end) electronics should be carried out in parallel but not independently





Note: apologies for any omission!

- @ Session 6 High Energy Physics
  - L. Burmistrov, "Cherenkov detector for proton Flux Measurement (CpFM)"

## • @ Session 10 – Cherenkov Detectors

- S. Hirose, "Development of the MCP-PMT for the Belle II TOP Counter"
- L. Castillo García, "MCP photon detectors studies for the TORCH detector"
- @ Session 11 Innovative Photodetectors
  - L. Hiirvonen, "Sub-exposure-time time resolution in wide-field time-correlated single photon counting imaging"





- @ Session 12 MCPs
  - Q. Sen "The Status of MCP-PMT R&D in China"
  - O. Siegmund, "Application of Atomic Layer Deposited Microchannel Plates to Imaging Photodetectors with High Time Resolution"
  - F. Andrea et al., "Latest results about the performances of amorphous silicon-based microchannel plate"
  - A. Lehmann et al., "Breakthrough in the Lifetime of Microchannel-Plate PMTs"
  - V. Yurevich, "Development and study of picosecond start and trigger detector for high-energy heavy ion experiments"
- @ Session 16 Readout Electronics
  - J. Lapington et al., "The capacitive division image readout; an imaging technique combining high time and spatial resolution"
  - M. Fiorini et al., "CLARO-CMOS: a fast, low power and radiation-hard front-end ASIC for single-photon counting in 0.35 micron CMOS technology"





## • @ Poster Session #2

- M. Minot et al., "Pilot Production & Commercialization of LAPPD™"
- L. Giudicotti, "Gain saturation in microchannel plate detectors"
- A. Tremsin, "Optimization of High Count Rate Photon Counting Detector with Microchannel Plates and Quad Timepix readout"

## • @ Poster Session #3

• S. Leach et al., "Optimising image resolution for photon-counting detectors using adaptive pulse processing"









## Solid materials (usually semiconductors)

## Multi-step process:

1. absorbed  $\gamma$ 's impart energy to electrons (e) in the material; If  $E_{\gamma} > E_{g}$ , electrons are lifted to conductance band.

→ In a Si-photodiode, these electrons can create a photocurrent. → Photon detected by Internal Photoeffect.

However, if the detection method requires extraction of the electron, 2 more steps must be accomplished:



- 2. energized e's diffuse through the material, losing part of their energy (~random walk) due to electron-phonon scattering.  $\Delta E \sim 0.05 \text{ eV}$  per collision. Free path between 2 collisions  $\lambda_f \sim 2.5$  5 nm  $\rightarrow$  escape depth  $\lambda_e \sim$  some tens of nm.
- 3. only e's reaching the surface with sufficient excess energy escape from it → External Photoeffect

$$E_{\gamma} = h \nu > W_{ph} = E_G + E_A$$

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## Light absorption in photocathode

 $N = N_0 \cdot exp(-\alpha d)$  $\lambda_{A} = 1/\alpha$ Red light ( $\lambda \approx 600$  nm)  $\alpha \approx 1.5 \cdot 10^5 \text{ cm}^{-1}$  $\lambda_A \approx 60 \text{ nm}$ Blue light ( $\lambda \approx 400$  nm)  $\alpha \approx 7 \cdot 10^5 \text{ cm}^{-1}$  $\lambda_{\rm A} \approx 15 \text{ nm}$ 

0.4

Blue light is stronger absorbed than red light !

→ Make semitransparent photocathode just as thick as necessary!

2.6

hv (eV)

Opaque photocathode









# (External) QE of typical semitransparent photo-cathodes





Bialkali: SbKCs, SbRbCs Multialkali: SbNa<sub>2</sub>KCs (alkali metals have low work function)





## 2 types of losses:

• Fresnel reflection at interface air/window and window/photocathode

 $\begin{array}{l} R_{Fresnel} = (n - 1)^2 \ / \ (n + 1)^2 \ n = refractive \ index \ (wavelength \ dependent!) \\ n_{glass} \simeq 1.5 \ R_{Fresnel} = 0.04 \ (per \ interface) \end{array}$ 

• Bulk absorption due to impurities or intrinsic cut-off limit. Absorption is proportional to window thickness



Schott











